

# ■ INTRODUCTION

SN6A512B is a series of single chip voice/dual tone melody synthesizer IC with 16\*64/8\*64 LCD direct drive capability which contains two 4-bit I/O ports, two optional 4-bit output ports and a tiny controller. By programming through the tiny controller, user's application including LCD display, section combination, trigger modes, output status, voice/melody playing and other logic functions and then be easily implemented.

# ■ FEATURES

- ◆ Single power supply 2.4V 5.1V
- Built in a tiny controller
- Two 4-bit I/O ports, two optional 4-bit output ports are provided
- 256\*4 bits RAM for programming usage are provided
- 256\*4 bits RAM for LCD display usage are provided
- Maximum 512k\*10 program ROM is provided
- Readable ROM code data
- Built in direct 16\*64/8\*64 LCD driver
- LCD 1/4 bias, 1/5 bias; 1/8 duty, 1/16 duty
- Built in a high quality speech synthesizer
- Adaptive playing speed from 2.5k-40kHz is provided
- Built in a dual tone melody generator
- Speech/Dual tone melody mixer is provided which SN6A512B series can play speech and dual tone melody simultaneously
- Fixed current D/A output is provided to drive external connected transistor for sound output
- PWM output is provided to drive external connected piezo buzzer



## ■ PIN ASSIGNMENT

Symbol	I/O	Function Description			
SEG1 ~ SEG56	0	Segment1~ 56 for LCD driver			
SEG57/P53 ~	0	Optional to be Segment57 ~ 60 or P53-P50			
SEG60/P50		Seg57-60: segment57 ~ 60 for LCD driver.			
		P53-P50: bit3-bit0 for output port 5.			
SEG61/P43 ~	0	Optional to be segment61 ~ 64 or P43-P40			
SEG64/P40		SEG61-64: segment61 ~ 64 for LCD driver.			
		P43-P40: Bit3-bit0 for output port 4.			
COM1-COM16	0	Com1-Com16 for LCD driver.			
GND		Negative power supply.			
P33-P30	I/O	Bit 3 to bit 0 of IO port 3.			
P23-P20	I/O	Bit 3 to bit 0 of IO port 2.			
BU1,BU2	0	Buzzer driver outputs.			
VO	0	D/A current output.			
RST	I	Reset pin with internal pull low.			
OSC	I	Oscillation component connection pin.			
TEST	I	For testing only.			
XIN,XOUT		32768 Hz Crystal connection pins.			
V <sub>DD</sub>	I	Positive power supply.			
VLCDR		LCD voltage adjusting pin.			
VLC1-VLC4		LCD voltage bias connection pins.			
WSUB	I	Well substrate of chip. Connected to the			
		highest voltage of chip (VDD or VLCDR).			



# ABSOLUTELY MAXIMUM RATING

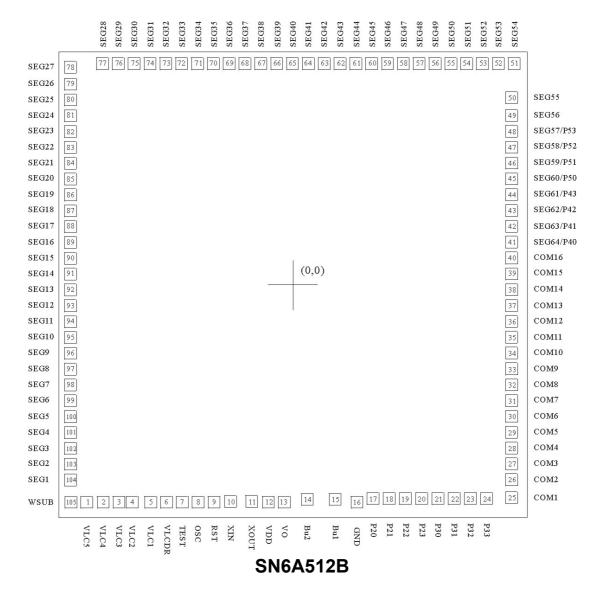
Items	Symbol	Min	Мах	Unit.
Supply Voltage	V <sub>DD</sub> -V	-0.3	6.0	V
Input Voltage	V <sub>IN</sub>	V <sub>SS</sub> -0.3	V <sub>DD</sub> +0.3	V
Operating	T <sub>OP</sub>	-20.0	70.0	°C
Temperature				
Storage Temperature	T <sub>STG</sub>	-55.0	125.0	°C

# ■ ELECTRICAL CHARACTERISTIC

ltem	Sym.	Min.	Тур.	Max.	Unit	Condition
Operating Voltage	V <sub>DD</sub>	2.4	3.0	5.1	V	
Standby current 1	I <sub>SBY1</sub>	-	2.5	3.5	иА	V <sub>DD</sub> =3V,both system clk and 32768 Hz clk are off
Operating current	I <sub>OPR</sub>	-	450		иA	$V_{DD}$ =3V, no load
Input current of ,P2,P3	I <sub>IH</sub>	-	3.0	10.0	uА	V <sub>DD</sub> =3V,V <sub>IN</sub> =3V
Drive current of P2,P3,P4,P5	I <sub>OD</sub>	2	-	-	mА	V <sub>DD</sub> =3V,V <sub>O</sub> =2.6V
large Sink current of P2,P3,P4,P5	I <sub>OS1</sub>	3	-	-	mА	V <sub>DD</sub> =3V,V <sub>O</sub> =0.4V
Input Pull Low Resistor	R	-	1	-	ΜΩ	V <sub>DD</sub> =3V
D/A output current	I <sub>VO</sub>	-	3.0	-	mА	V <sub>DD</sub> =3V,V <sub>O</sub> =0.7V
Buzzer drive current	I <sub>BZD</sub>		15		mА	V <sub>DD</sub> =3V,V <sub>O</sub> =1.5V
Buzzer sink current	I <sub>BZS</sub>		15		mА	V <sub>DD</sub> =3V,V <sub>O</sub> =1.5V
Oscillation resistor	R	-	330	-	ΚΩ	V <sub>DD</sub> =3V
Oscillation Freq.	Fosc	-	1.0	-	MHZ	V <sub>DD</sub> =3V



## BONDING PAD



Note: The substrate MUST be connected to Vss in PCB layout.



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